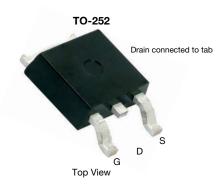


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Vishay Siliconix

Automotive P-Channel 40 V (D-S) 175 °C MOSFET

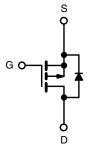


PRODUCT SUMMARY					
V _{DS} (V)	-40				
$R_{DS(on)}(\Omega)$ at $V_{GS} = -10 \text{ V}$	0.0115				
$R_{DS(on)}(\Omega)$ at $V_{GS} = -4.5 \text{ V}$	0.0150				
I _D (A)	-50				
Configuration	Single				
Package	TO-252				

FEATURES

- TrenchFET® power MOSFET
- Package with low thermal resistance
- 100 % R_g and UIS tested
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912





P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)				
PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-source voltage		V_{DS}	-40	V
Gate-source voltage		V _{GS}	± 20	V
Continuous drain current	T _C = 25 °C a	I _D	-50	
	T _C = 125 °C		-31	
Continuous source current (diode conduction)	Is	-50	Α	
Pulsed drain current ^b		I _{DM}	-180	
Single pulse avalanche current	L = 0.1 mH	I _{AS}	-27	
Single pulse avalanche energy	L = 0.1 IIII	E _{AS}	36.4	mJ
Maximum power dissipation ^b	T _C = 25 °C	P _D	62	W
	T _C = 125 °C		20	VV
Operating junction and storage temperature ra	nge	T _J , T _{stg}	-55 to +175	°C

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	LIMIT	UNIT		
Junction-to-ambient	PCB mount c	R _{thJA}	50	°C/W		
Junction-to-case (drain)		R _{thJC}	2.4	C/VV		

Notes

- a. Package limited
- b. Pulse test; pulse width $\leq 300~\mu s,\,duty~cycle \leq 2~\%$
- c. When mounted on 1" square PCB (FR4 material)



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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static								
Drain-source breakdown voltage	V_{DS}	V _{GS} = 0 V, I _D = -250 μA		-40	-	-	V	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$		-1.5	-2	-2.5	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA	
		V _{GS} = 0 V	V _{DS} = -40 V	-	-	-1		
Zero gate voltage drain current	I_{DSS}	V _{GS} = 0 V	V _{DS} = -40 V, T _J = 125 °C	=	-	-50	μΑ	
		V _{GS} = 0 V	V _{DS} = -40 V, T _J = 175 °C	-	-	-250	İ	
On-state drain current ^a	I _{D(on)}	V _{GS} = -10 V	$V_{DS} \ge 5 V$	-30	-	-	Α	
		V _{GS} = -10 V	I _D = -30 A	-	0.0095	0.0115		
During and state was interest 2	Б	V _{GS} = -10 V	I _D = -30 A, T _J = 125 °C	-	-	0.0171	Ω	
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = -10 V	I _D = -30 A, T _J = 175 °C	-	-	0.0203		
		V _{GS} = -4.5 V	I _D = -25 A	-	0.0121	0.0150	i	
Forward transconductance ^b	9 _{fs}	V _{DS} =	-15 V, I _D = -30 A	-	71	-	S	
Dynamic ^b					•			
Input capacitance	C _{iss}			-	4872	6600		
Output capacitance	C _{oss}	$V_{GS} = 0 V$	V _{DS} = -25 V, f = 1 MHz	-	344	500	pF	
Reverse transfer capacitance	C _{rss}			-	316	450		
Total gate charge ^c	Qg			-	76	115	nC	
Gate-source charge ^c	Q _{gs}	V _{GS} = -10 V	$V_{DS} = -20 \text{ V}, I_{D} = -30 \text{ A}$	-	11.5	-		
Gate-drain charge ^c	Q _{gd}			-	13.5	-		
Gate resistance	R_g	f = 1 MHz		2	4	6	Ω	
Turn-on delay time ^c	t _{d(on)}			-	13	20		
Rise time ^c	t _r	V_{DD} = -20 V, R_L = 0.7 Ω I_D \cong -30 A, V_{GEN} = -10 V, R_g = 1 Ω		-	7	15	ns	
Turn-off delay time ^c	t _{d(off)}			=	66	100		
Fall time ^c	t _f			-	28	45		
Source-Drain Diode Ratings and Charac	teristics b							
Pulsed current ^a	I _{SM}			-	-	-180	Α	
Forward voltage	V_{SD}	I _F = -30 A, V _{GS} = 0 V		1	-0.9	-1.5	V	
Body diode reverse recovery time	t _{rr}	I _F = -30 A, di/dt = 100 A/μs		-	43	90	ns	
Body diode reverse recovery charge	Q_{rr}			-	45	100	nC	
Reverse recovery fall time	t _a			-	26	-		
Reverse recovery rise time	t _b			-	17	-	ns	
Body diode peak reverse recovery current	I _{RM(REC)}			-	-2.8	-	Α	

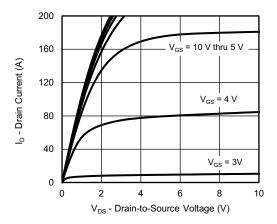
Notes

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %
- b. Guaranteed by design, not subject to production testing
- c. Independent of operating temperature

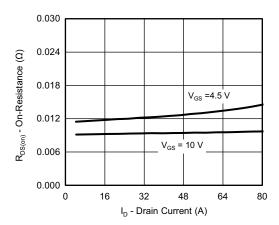
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



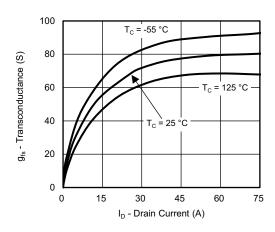
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



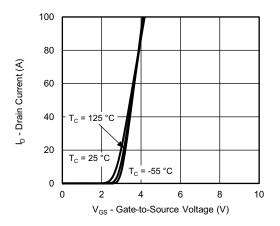
Output Characteristics



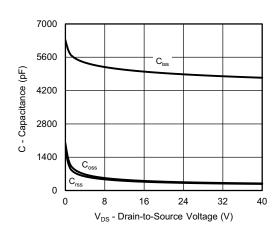
On-Resistance vs. Drain Current



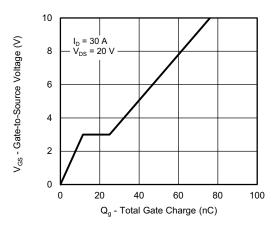
Transconductance



Transfer Characteristics



Capacitance

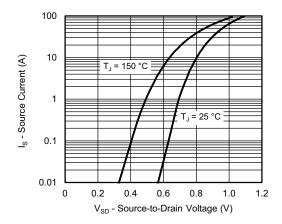


Gate Charge

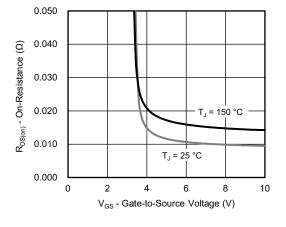
For technical questions, contact: automostechsu



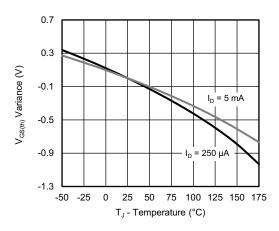
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



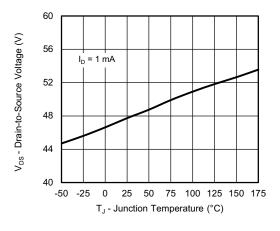
Source Drain Diode Forward Voltage



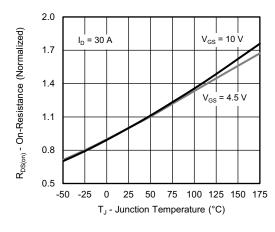
On-Resistance vs. Gate-to-Source Voltage



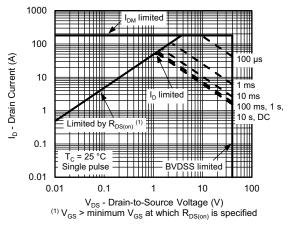
Threshold Voltage



Drain Source Breakdown vs. Junction Temperature



On-Resistance vs. Junction Temperature

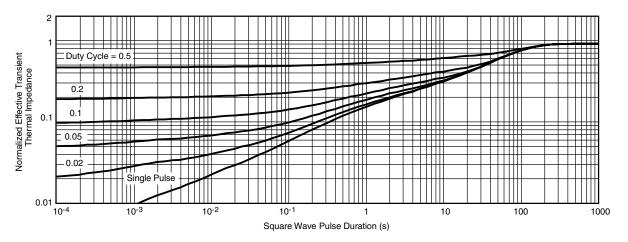


Safe Operating Area

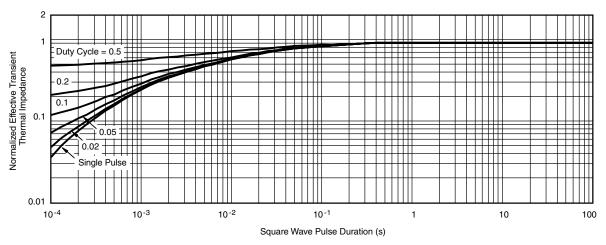
For technical questions, contact: automostechsu



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Note

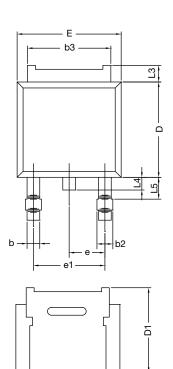
- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction to Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction to Case (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

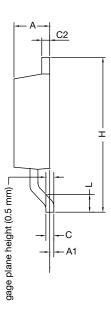
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TO-252AA Case Outline





	MILLIN	METERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	4.10	-	0.161	-	
Е	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28	BSC	0.090	BSC	
e1	4.56 BSC		0.180 BSC		
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.01	1.52	0.040	0.060	
ECN: T13-0592-Rev. A, 02-Sep-13					

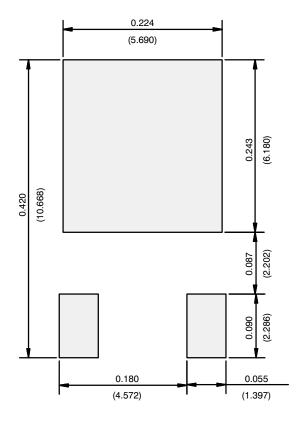
DWG: 6019

Note

• Dimension L3 is for reference only.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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